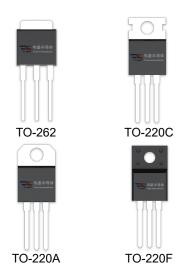
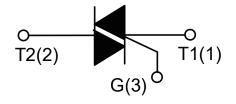
#### **DESCRIPTION:**

With high ability to withstand the shock loading of large current, BTB12-600CW series triacs provide high dv/dt rate with strong resistance to electromagnetic interface. With high commutation performances, 3 quadrants products especially recommended for use on inductive load.



#### **MAIN FEATURES**

Symbol	Symbol Value	
I <sub>T(RMS)</sub> 12		А
V <sub>DRM</sub> /V <sub>RRM</sub>	600/800/1200	V



### **ABSOLUTE MAXIMUM RATINGS**

Parameter		Symbol	Value	Unit
Storage junction temperature range		T <sub>stg</sub>	-40-150	$^{\circ}\!\mathbb{C}$
Operating junction temperature range		Tj	-40-125	$^{\circ}\!\mathbb{C}$
Repetitive peak of	-state voltage (Tj=25℃)	V <sub>DRM</sub>	600/800/1200	V
Repetitive peak re	tive peak reverse voltage (Tj=25℃)		600/800/1200	V
Non repetitive surge peak Off-state voltage		V <sub>DSM</sub>	V <sub>DRM</sub> +100	V
Non repetitive pea	k reverse voltage	V <sub>RSM</sub>	V <sub>RRM</sub> +100	V
	TO-220A(Ins) (Tc=85°C)			
RMS on-state current	TO-262/ TO-220A(Non-Ins)/ TO-220C(Tc=100°C) TO-220F(Ins) (Tc=80°C)	I <sub>T(RMS)</sub>	12	Α

Non repetitive surge peak on-state current (full cycle, F=50Hz)		I <sub>TSM</sub>	120	А
I <sup>2</sup> t value for fusing (tp=10ms)		l²t	78	A <sup>2</sup> s
Critical rate of rise of on-state current ( $I_G = 2 \times I_{GT}$ )		dl/dt	50	A/µs
Peak gate current		I <sub>GM</sub>	4	Α
Average gate power dissipation		P <sub>G(AV)</sub>	1	W
Peak gate power		P <sub>GM</sub>	5	W

# **ELECTRICAL CHARACTERISTICS** ( $T_j$ =25 $^{\circ}$ C unless otherwise specified)

# 3 Quadrants

Symbol	Test Condition Quadrant		Value			Unit		
		Quaurant		BW	CW	sw	TW	Offic
Ідт	V <sub>D</sub> =12V R <sub>L</sub> =33Ω	I - II -III	MAX	50	35	10	5	mA
V <sub>G</sub> T	VD=12V RL=3312	I - II -III	MAX		1.3	3		V
V <sub>GD</sub>	$V_D = V_{DRM} T_j = 125$ °C RL = 3.3KΩ	I - II -III	MIN	0.2		V		
I <sub>L</sub> I <sub>G</sub> = 1.2I <sub>GT</sub>	1 4 01	I -III	I -III MAX	80	50	30	20	m A
	IG = 1.2IGT	II	IVIAA	90	60	40	30	mA
Ін	I <sub>T</sub> =100mA		MAX	60	40	20	15	mA
dV/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =125℃		MIN	1000	500	200	100	V/µs
(dl/dt)c	Without snubber T <sub>j</sub> =125℃		MIN	12	6.5	-	-	A/ms

## 4 Quadrants

Symbol	Test Condition	Quadrant		Value		Unit
	rest Condition			В	С	Oilit
lo-		I - II -III	MAX	50	25	mΛ
I <sub>GT</sub>	V <sub>D</sub> =12V R <sub>L</sub> =33Ω	IV	IVIAA	70	50	mA
V <sub>G</sub> T		ALL	MAX	1	.3	V
V <sub>GD</sub>	$V_D = V_{DRM} T_j = 125^{\circ}C$ $R_L = 3.3 K\Omega$	ALL	MIN	0.2		V
IL	1 -4 01	I -III-IV	MAX	50	40	mA
	I <sub>G</sub> =1.2I <sub>GT</sub>	II	IVIAA	100	80	IIIA

lн	I <sub>T</sub> =100mA	MAX	50	25	mA
dV/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =125℃	MIN	500	200	V/µs
(dV/dt)c	(dl/dt)c=5.3A/ms T <sub>j</sub> =125℃	MIN	10	5	V/µs

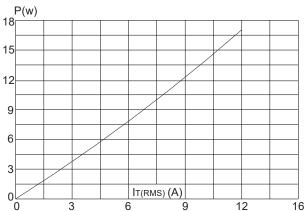
## **STATIC CHARACTERISTICS**

Symbol	Parameter		Value(MAX)	Unit
V <sub>TM</sub>	I <sub>тм</sub> =17A tp=380µs	Tj=25℃	1.5	V
IDRM	\/\/\/	T <sub>j</sub> =25℃	5	μΑ
I <sub>RRM</sub>	$V_D = V_{DRM} V_R = V_{RRM}$	T <sub>j</sub> =125℃	1	mA

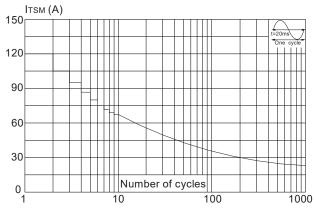
# **THERMAL RESISTANCES**

Symbol	Parameter		Value	Unit
		TO-220A(Ins)	2.3	
R <sub>th(j-c)</sub>	junction to case(AC)	TO-262/ TO-220A(Non-Ins)/ TO-220C	1.4	°C/W
		TO-220F(Ins)	2.5	

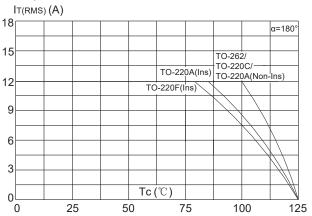
**FIG.1** Maximum power dissipation versus RMS on-state current



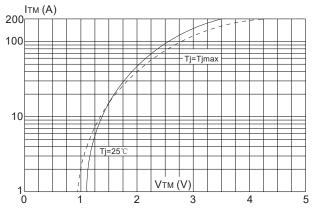
**FIG.3:** Surge peak on-state current versus number of cycles



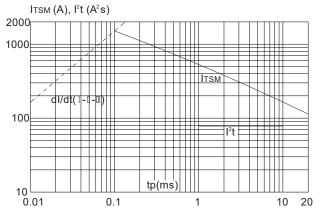
**FIG.2:** RMS on-state current versus case temperature



**FIG.4:** On-state characteristics (maximum values)



**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<20ms, and corresponging value of  $I^2t$  (dI/dt( I-I-II) < 50A/ $\mu$ s)



**FIG.6:** Relative variations of gate trigger current, holding current and latching current versus junction temperature

